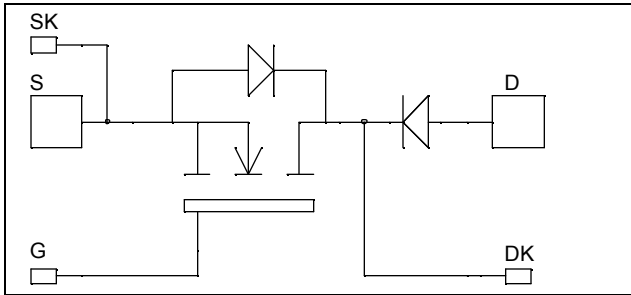


Single switch
with Series diodes
MOSFET Power Module

$V_{DSS} = 1200V$
 $R_{DSon} = 70m\Omega$ typ @ $T_j = 25^\circ C$
 $I_D = 171A$ @ $T_c = 25^\circ C$



Application

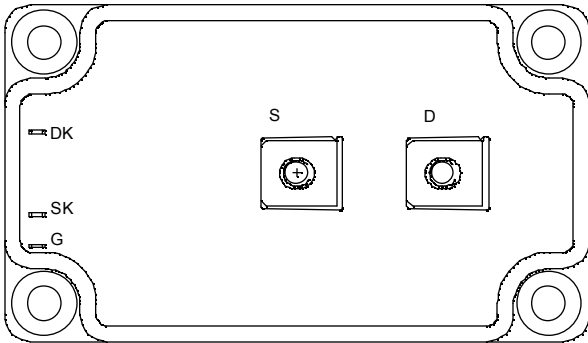
- Zero Current Switching resonant mode

Features

- Power MOS 7[®] MOSFETs
 - Low R_{DSon}
 - Low input and Miller capacitance
 - Low gate charge
 - Avalanche energy rated
 - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
 - Symmetrical design
 - M5 power connectors
- High level of integration
- AlN substrate for improved thermal performance


Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Low profile
- RoHS Compliant



Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V_{DSS}	Drain - Source Breakdown Voltage	1200	V
I_D	Continuous Drain Current	$T_c = 25^\circ C$	171
		$T_c = 80^\circ C$	126
I_{DM}	Pulsed Drain current	684	A
V_{GS}	Gate - Source Voltage	± 30	V
R_{DSon}	Drain - Source ON Resistance	80	$m\Omega$
P_D	Maximum Power Dissipation	$T_c = 25^\circ C$	5000
I_{AR}	Avalanche current (repetitive and non repetitive)	24	A
E_{AR}	Repetitive Avalanche Energy	50	mJ
E_{AS}	Single Pulse Avalanche Energy	3200	

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}, V_{DS} = 1200\text{V}$			1.5	mA
		$V_{GS} = 0\text{V}, V_{DS} = 1000\text{V}$	$T_j = 25^\circ\text{C}$		6	
$R_{DS(on)}$	Drain – Source on Resistance	$V_{GS} = 10\text{V}, I_D = 85.5\text{A}$		70	80	m Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 30\text{mA}$	3		5	V
I_{GSS}	Gate – Source Leakage Current	$V_{GS} = \pm 30\text{V}, V_{DS} = 0\text{V}$			± 600	nA

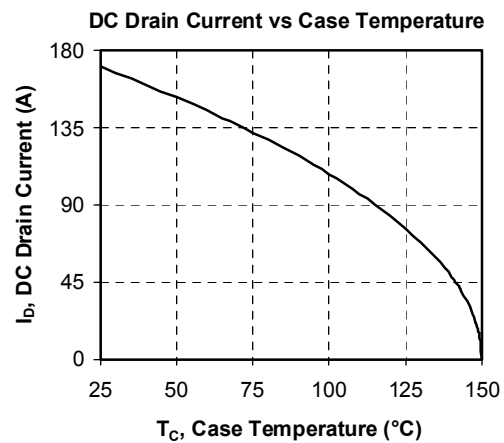
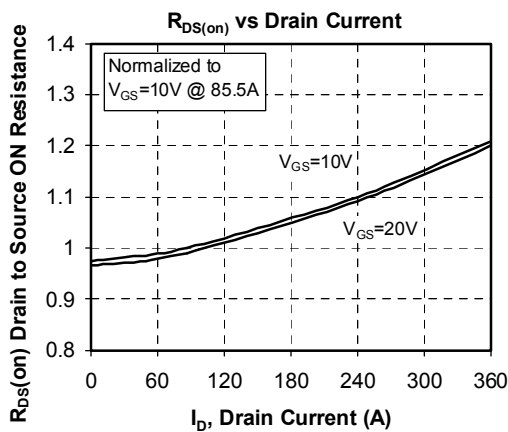
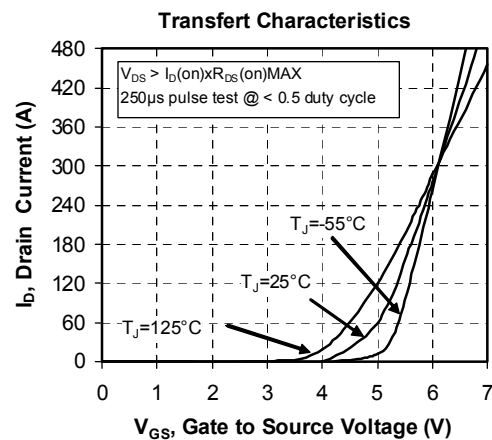
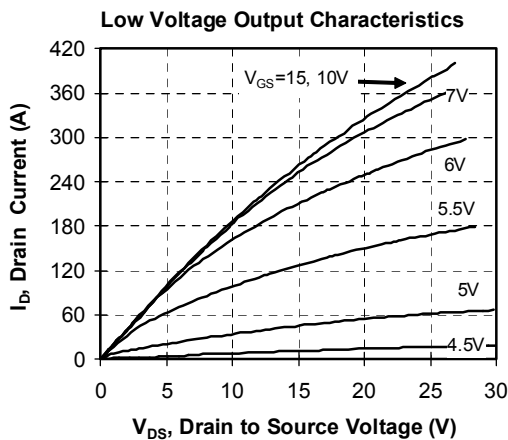
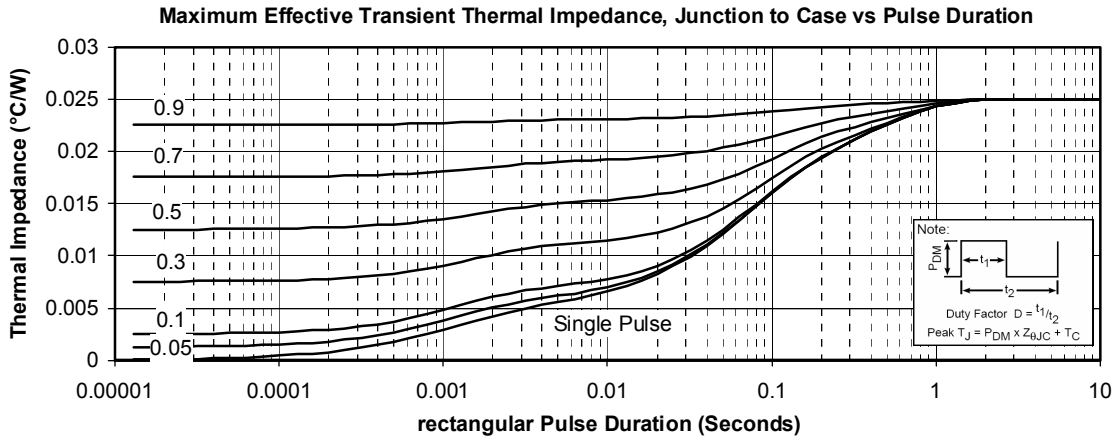
Dynamic Characteristics

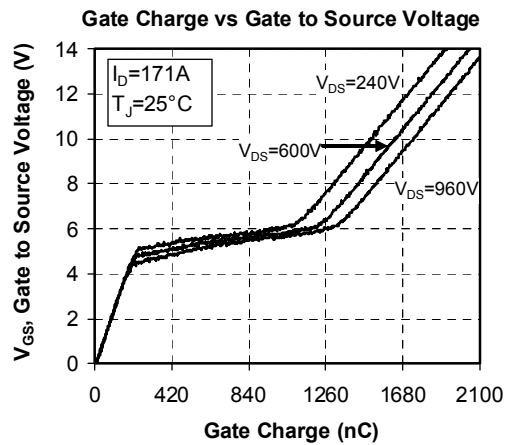
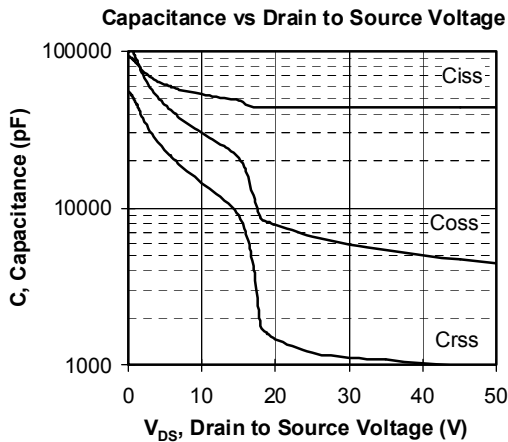
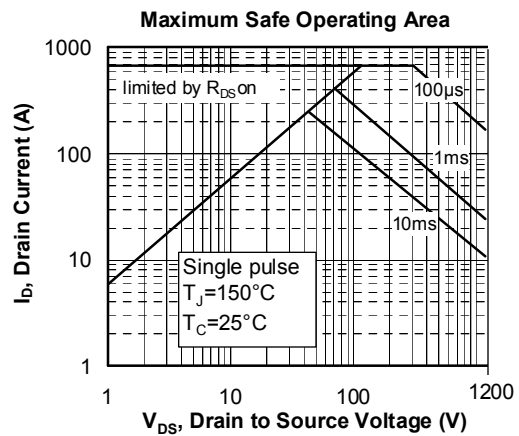
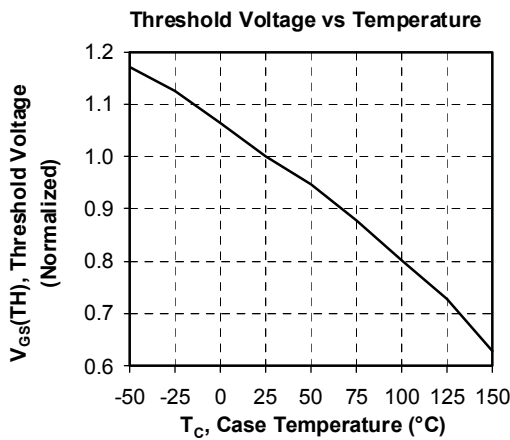
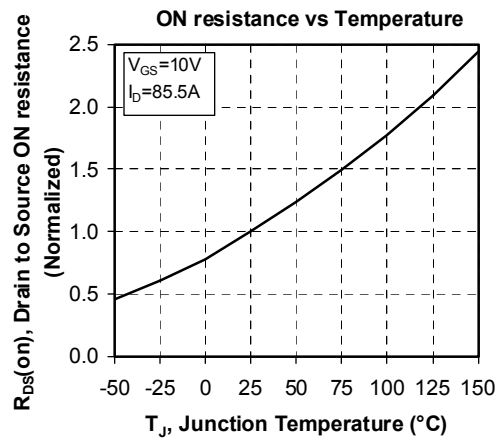
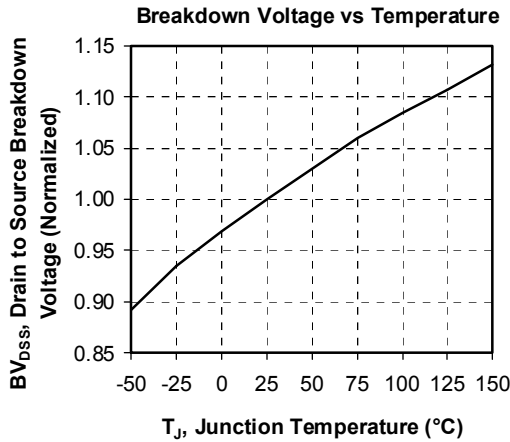
Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
C_{iss}	Input Capacitance	$V_{GS} = 0\text{V}$		43.5		nF
C_{oss}	Output Capacitance	$V_{DS} = 25\text{V}$		6.6		
C_{rss}	Reverse Transfer Capacitance	$f = 1\text{MHz}$		1.2		
Q_g	Total gate Charge	$V_{GS} = 10\text{V}$		1650		nC
Q_{gs}	Gate – Source Charge	$V_{Bus} = 600\text{V}$		192		
Q_{gd}	Gate – Drain Charge	$I_D = 171\text{A}$		1074		
$T_{d(on)}$	Turn-on Delay Time	Inductive switching @ 125°C		20		ns
T_r	Rise Time	$V_{GS} = 15\text{V}$		17		
$T_{d(off)}$	Turn-off Delay Time	$V_{Bus} = 800\text{V}$		245		
T_f	Fall Time	$I_D = 171\text{A}$ $R_G = 0.8\Omega$		62		
E_{on}	Turn-on Switching Energy	Inductive switching @ 25°C		7.6		mJ
E_{off}	Turn-off Switching Energy	$V_{GS} = 15\text{V}, V_{Bus} = 800\text{V}$ $I_D = 171\text{A}, R_G = 0.8\Omega$		6.9		
E_{on}	Turn-on Switching Energy	Inductive switching @ 125°C		13.8		mJ
E_{off}	Turn-off Switching Energy	$V_{GS} = 15\text{V}, V_{Bus} = 800\text{V}$ $I_D = 171\text{A}, R_G = 0.8\Omega$		8.5		

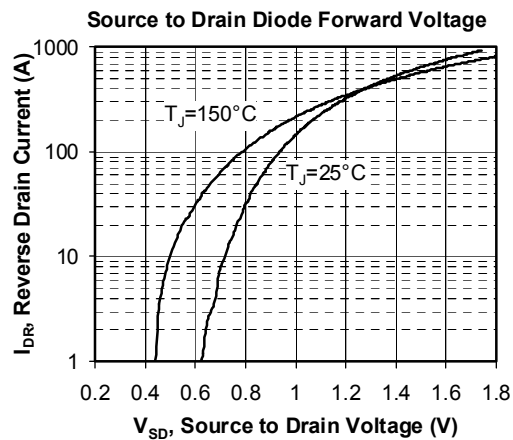
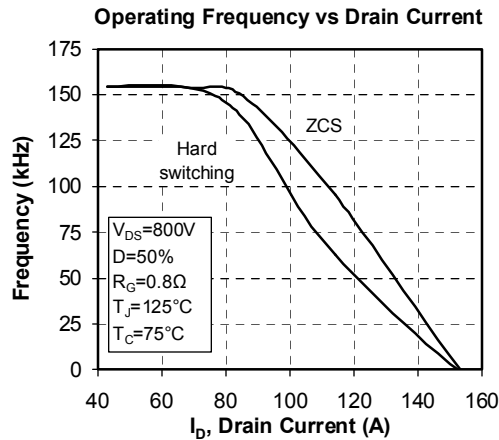
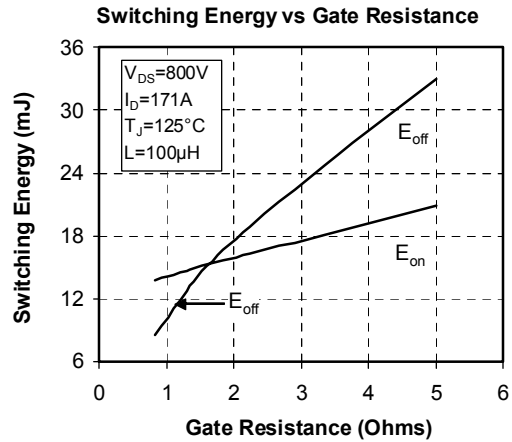
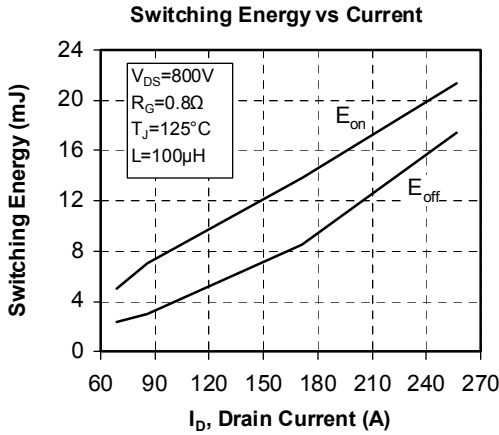
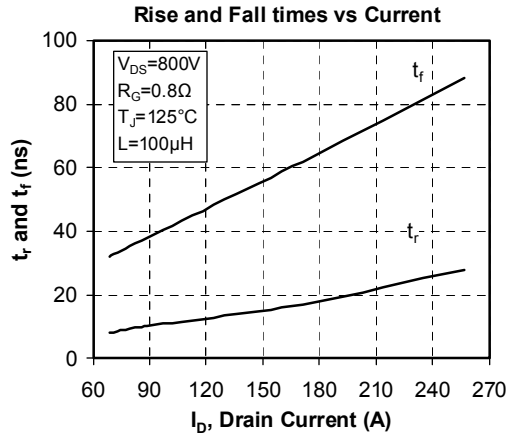
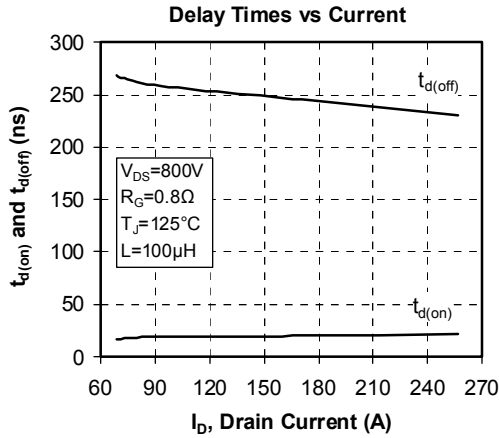
Series diode ratings and characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
V_{RRM}	Maximum Repetitive Reverse Voltage		1200			V
I_{RM}	Maximum Reverse Leakage Current	$V_R = 1200\text{V}$	$T_j = 25^\circ\text{C}$		750	μA
			$T_j = 125^\circ\text{C}$		1000	
I_F	DC Forward Current			240		A
V_F	Diode Forward Voltage	$I_F = 240\text{A}$		2	2.5	V
		$I_F = 480\text{A}$		2.3		
		$I_F = 240\text{A}$	$T_j = 125^\circ\text{C}$	1.8		
t_{rr}	Reverse Recovery Time	$I_F = 240\text{A}$ $V_R = 800\text{V}$ $di/dt = 800\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$	400		ns
			$T_j = 125^\circ\text{C}$	470		
Q_{rr}	Reverse Recovery Charge	$I_F = 240\text{A}$ $V_R = 800\text{V}$ $di/dt = 800\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$	4.8		μC
			$T_j = 125^\circ\text{C}$	16		

Typical Performance Curve







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